PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masato AKAO	07/06/2009
Tetsujiro KONDO	07/07/2009
Kazutaka ANDO	07/09/2009
Yoshihito FUJIWARA	07/15/2009

RECEIVING PARTY DATA

Name:	SONY CORPORATION
Street Address:	1-7-1 Konan, Minato-ku
City:	Tokyo
State/Country:	Japan
Postal Code:	108-0075

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12507951	

CORRESPONDENCE DATA

Fax Number: (703)413-2220

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (703) 413-3000

Email: bgalvez@oblon.com

Correspondent Name: Oblon, Spivak, et al.

Address Line 1: 1940 Duke Street

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: 345906US8

NAME OF SUBMITTER: Byron F. Galvez

Total Attachments: 2

source=345906USASSIGN#page1.tif

PATENT REEL: 023000 FRAME: 0794 OF \$40.00 1250/951

500918746

source=345906USASSIGN#page2.tif

PATENT REEL: 023000 FRAME: 0795

Docket Number:

ASSIGNMENT	
WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in INFORMATION PROCESSING APPARATUS, INFORMATION PROCESSING SYSTEM, AND INFORMATION PROCESSING METHOD	
for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name	
and address;	
AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;	
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficience of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;	
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;	
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;	
And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;	
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.	
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:, Filing Date:	
This assignment executed on the dates indicated below.	
Masato AKAO July 6, 2009	
Name of first or sole inventor Execution date of U.S. Patent Application	
Kanagawa, Japan	
Residence of first or sole inventor	
Masato Okao Signature of first or sole inventor Date of this assignment	
Signature of first or sole inventor Date of this assignment	

PATENT REEL: 023000 FRAME: 0796

Tetsujiro KONDO	T. ol 7. 7.55
Name of second inventor	Execution date of U.S. Patent Application
Tokyo, Japan	
Residence of second inventor	
Signature of second inventor	July 7, in 9 Date of this assignment
Signature of second inventor	Date of this assignment
Kazutaka ANDO	Execution date of U.S. Patent Application
Name of third inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of third inventor	
Residence of third inventor. Signature of third inventor	July 9, 2009 Date of this assignment
Signature of third inventor	Date of this assignment
Yoshihito FUJIWARA	7.1.2049
Name of fourth inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	, and a second representation
Residence of fourth inventor	
Gashikita Thuringan	7, 1, 1+ 2009
Signature of fourth inventor	Jaly 15, 2009 Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT REEL: 023000 FRAME: 0797

RECORDED: 07/24/2009